

LL05BT1006B

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100W Surface Mount TVS Bi-Directional For ESD Protection-5.0V

Features

- 100Watts peak pulse power per ($t_p=8/20\mu s$).
- Working voltage : 5V.
- Low leakage current.
- Provide transient protection:
IEC 61000-4-2 (ESD) Level 4, $\pm 25KV$ (Air), $\pm 22KV$ (Contact).
- IEC 61000-4-4 (EFT) 40A (5/50ns).
- We declare that the material of product compliance with RoHS requirements.
- Suffix "-H" indicates Halogen-free parts, ex.LL05BT1006B-H.

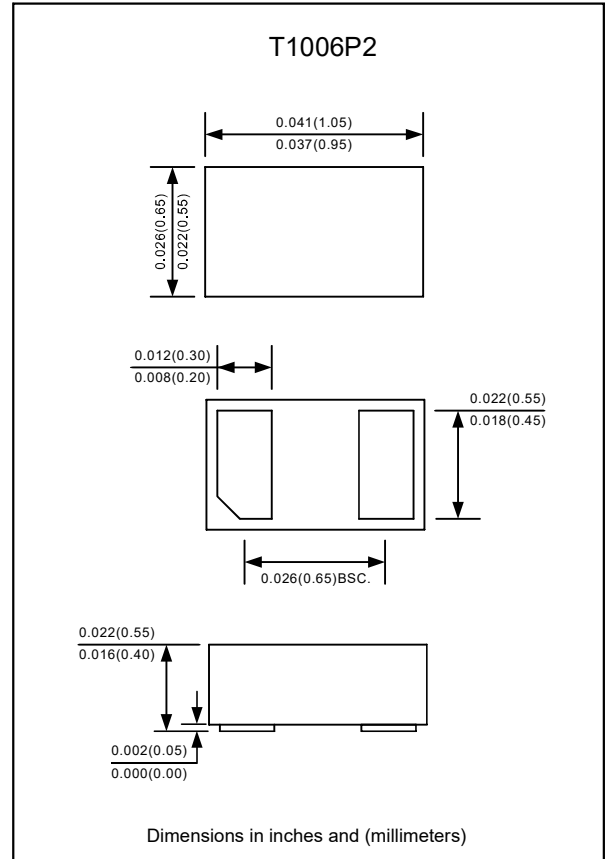
Applications

- Cell phone handsets and accessories.
- Display ports.
- MDDI ports.
- USB ports.
- Digital visual interface (DVI).
- PCI Express and serial SATA ports.

Mechanical data

- T1006P2 package
- Molding compound flammability rating : UL94V-0
- Making part number, data code.
- Packaging : Tape and reel.
- Weight : Approximated 0.73 mg.

Package outline



Maximum ratings (at $T_A=25^\circ C$ unless otherwise noted)

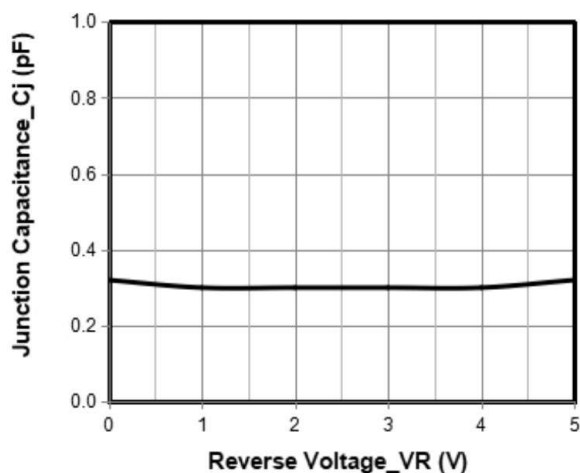
Parameter	Symbol	Value	Unit
Peak pulse power ($t_p=8/20\mu s$)	P_{PP}	100	W
Peak pulse current ($t_p=8/20\mu s$)	I_{PP}	4	A
ESD Per IEC 61000-4-2 (Air)	V_{ESD}	± 25	KV
ESD Per IEC 61000-4-2 (Contact)		± 22	
Operating temperature	T_{OPT}	+125	$^\circ C$
Storage temperature	T_{STG}	-55 to +150	$^\circ C$

Electrical characteristics (at $T_A=25^\circ C$ unless otherwise noted)

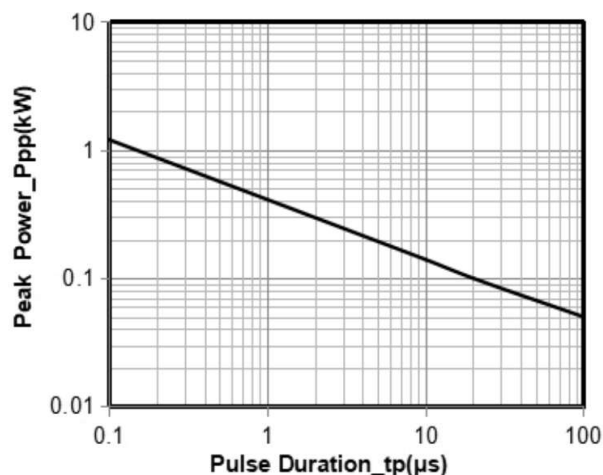
Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Reverse stand-off voltage		V_{RWM}			5.0	V
Breakdown voltage	$I_T=1mA$	V_{BR}	6.5		9.5	V
Reverse leakage current	$V_{RWM}=5V$	I_R			0.2	μA
Clamping voltage	$I_{PP}=1A, t_p=8/20\mu s$	V_C			12	V
	$I_{PP}=4A, t_p=8/20\mu s$	V_C			25	V
Junction capacitance	$V_R=0V, f=1MHz$	C_{ESD}		0.3	0.5	pF

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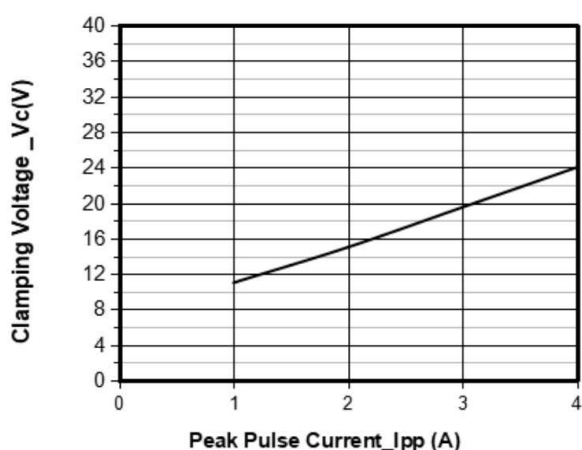
Rating and characteristic curves



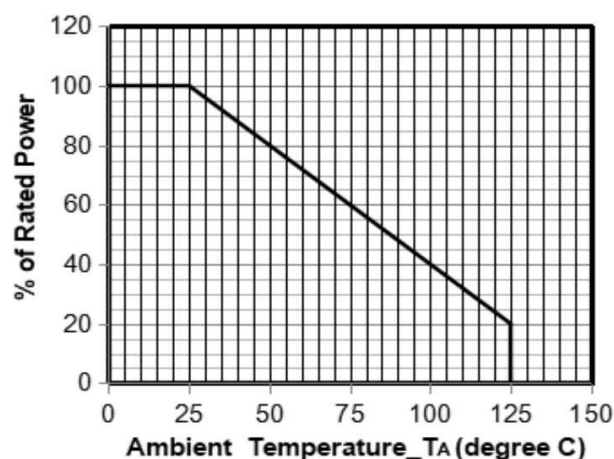
Junction Capacitance vs. Reverse Voltage



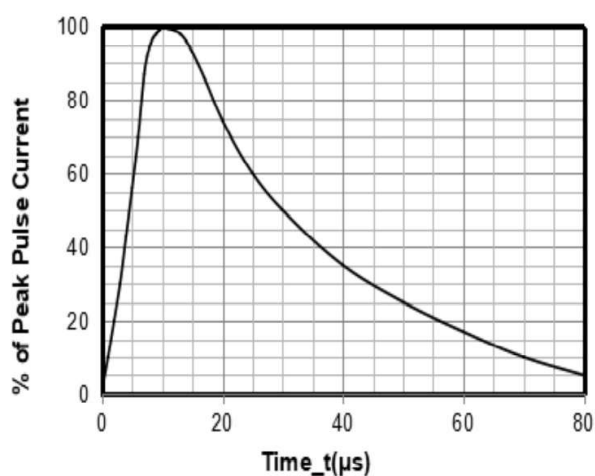
Peak Pulse Power vs. Pulse Time



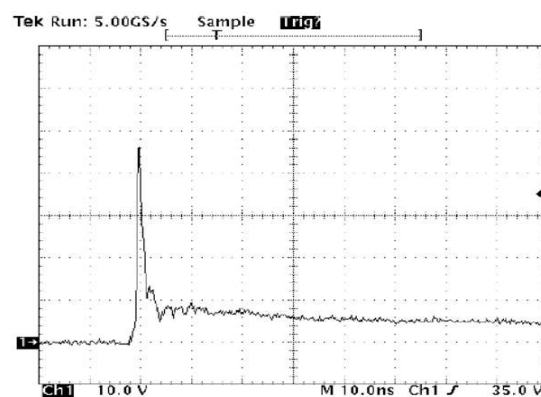
Clamping Voltage vs. Peak Pulse Current



Power Derating Curve



8 X 20 s Pulse Waveform



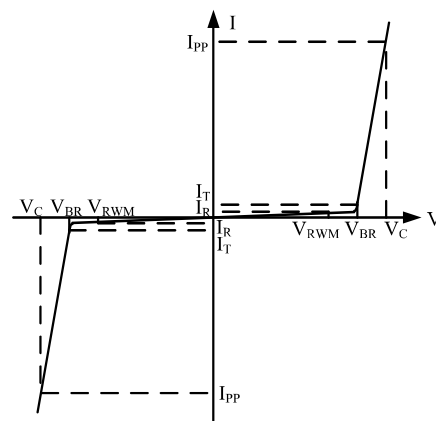
Note: Data is taken with a 10x attenuator

ESD Clamping Voltage

8 kV Contact per IEC61000-4-2

LL05BT1006B**Electrical Parameters ($T_A=25^{\circ}\text{C}$)**

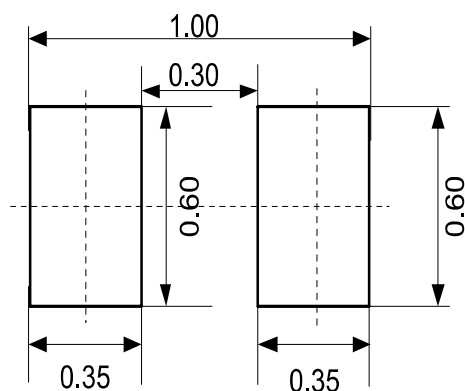
Symbol	Parameter
V_{RWM}	Nominal Reverse Working Voltage
I_{R}	Reverse Leakage Current @ V_{RWM}
V_{BR}	Reverse Breakdown Voltage @ I_{T}
I_{T}	Test Current for Reverse Breakdown
V_{C}	Clamping Voltage @ I_{PP}
I_{PP}	Maximum Peak Pulse Current
C_{ESD}	Parasitic Capacitance
V_{R}	Reverse Voltage
f	Small Signal Frequency



Bi-Directional TVS

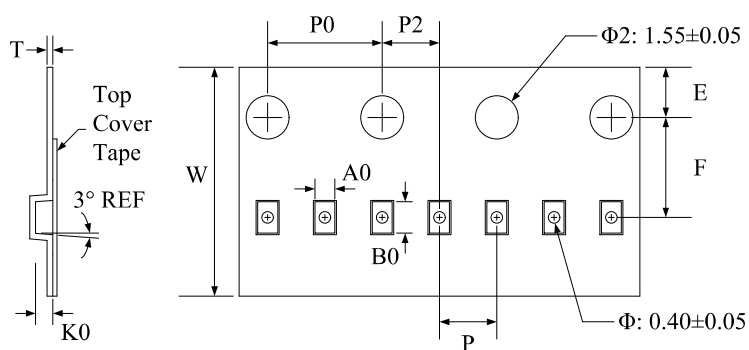
Pinning information

Marking Code	Symbol
21	
5F	

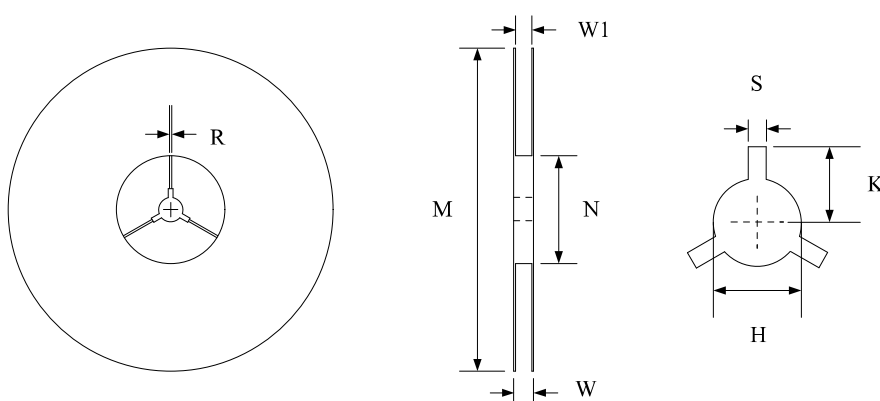
Suggested solder pad layout

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Packing information



Symbol	W	A0	B0	K0	E	F	P	P0	P2	T
Dimensions (mm)	8.00±0.1	0.7±0.05	1.15±0.05	0.55±0.05	1.75±0.1	3.5±0.05	2.0±0.1	4.0±0.1	2.0±0.05	0.2±0.05



Symbol	Reel Size	M	N	W	W1	H	S	K	R
Dimensions (mm)	Φ178	178.0±1.0	60.0±1.0	11.5±0.5	9.0±0.5	13.0±0.5	2.0±0.1	11.0±0.2	1.0±0.05

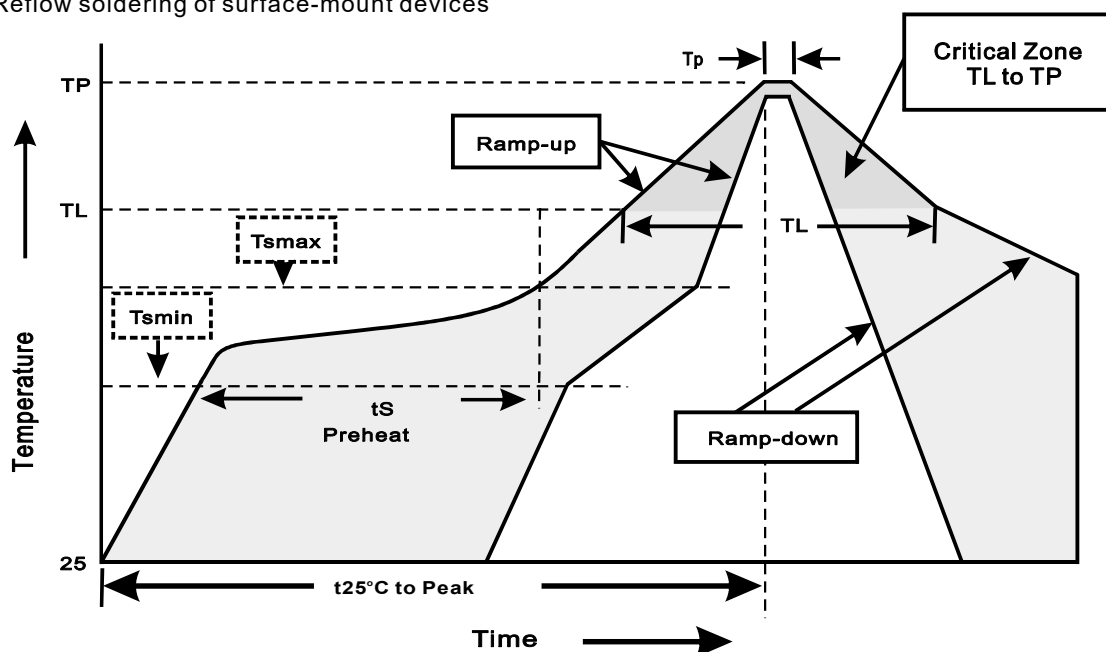
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Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
T1006P2	7"	10,000	4.0	100,000	183*123*183	178	382*257*387	800,000	15.0

Suggested thermal profiles for soldering processes

- 1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%
- 2.Reflow soldering of surface-mount devices



3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T _L to T _P)	<3°C/sec
Preheat -Temperature Min(T _{smmin}) -Temperature Max(T _{smmax}) -Time(min to max)(t _s)	150°C 200°C 60~120sec
T _{smmax} to T _L -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(T _L) -Time(t _L)	217°C 60~260sec
Peak Temperature(T _P)	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t _P)	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes